

APPROVAL SHEET

RF Switch Series – RoSH Compliance

SP6T MIPI Diversity Switch

Halogens Free Product

Any 2G/3G/4G Antenna Diversity For Receive System

P/N: RFASWH526BTF03

FEATURES

- Low Insertion Loss and Low Distortion
- Broadband frequency range: 0.4 to 2.7 GHz
- High Isolation and linearity
- Integrated MIPI RFFE Slave Controller
- High ESD tolerance of 2kV HBM at all pins
- Small LGA(14-pin, 2.0 x 2.0 x 0.55 mm³) package
- <u>M</u>oisture <u>Sensitive</u> <u>Level 3 (MSL3)</u>

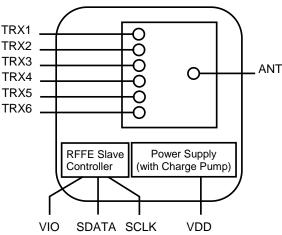
Description

- The RFASWH526BTF03 is a Single Pole, Six Throw (SP6T) antenna switch with an integrated Mobile Industry Processor Interface (MIPI) controller. Using an advanced switching technology, the RFASWH526BTF03 maintains low insertion and high isolation, which makes it an ideal choice for UMTS, CDMA2000, EDGE, GSM, and LTE applications.
- The design integrated six low loss TRX ports. The switch also has an excellent 2nd/3rd Order Intermodulation Distortion (IMD2/IMD3) performance.
- Switching is controlled by the MIPI decoder and High ESD tolerance of 2kV HBM at all pins.
- No blocking capacitor requirements on the RF paths as long as no DC voltage is applied. The RFASWH526BTF03 is manufactured in a compact, 2.0 x 2.0 x 0.55 mm³ package.
- The functional block diagram is shown in Figure 1. The pin assignment and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

Application

2G/3G/4G multimode cellular handsets (LTE, UMTS, CDMA2000, EDGE, GSM, TDD-LTE, TD-SCDMA)

Block Diagram and Pin Out (Top View)





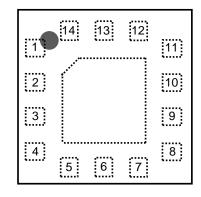


Figure 2. RFASWH526BTF03 Pin assignment

Table 1. RFASWH526BTF03 Pin Descriptions

Pin #	Name	Description	Pin#	Name	Description
1	TRx5	RF path 5	8	N/C	Not connected
2	TRx3	RF path 3	9	TRx2	RF path 2
3	TRx1	RF path 1	10	TRx4	RF path 4
4	VDD	DC power supply	11	TRx6	RF path 6
5	VIO	RFFE Interface Power Supply	12	N/C	Not connected
6	SDATA	RFFE Data input/output	13	ANT	Antenna port
7	SCLK	RFFE Clock Input	14	N/C	Not connected

Note 1: Bottom ground paddles must be connected to ground.

Application Circuit

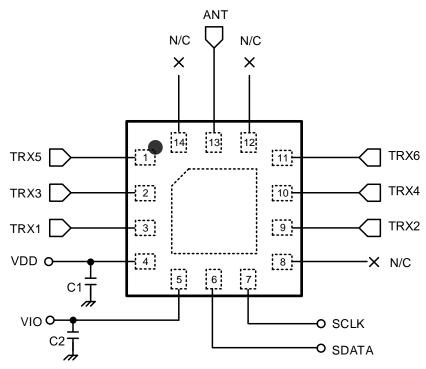


Figure 3. RFASWH526BTF03 Application Circuit

Note: No DC Blocking capacitors are required for all RF ports unless DC is biased externally.

Parts List

Parts No.	Value	
C1-C2	0.1 μF	



Table 2. RFASWH526BTF03 Absolute Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Units
RFx Input power	P _{IN}		+26	dBm
Supply Voltage	VDD		3.5	V
Interface Supply Voltage	VIO		2.0	V
Control Input/ Output Voltage Range (SDATA, SCLK)	V _{IN_OUT}		2.0	V
Storage temperature	T _{STG}	-45	+125	°C
Operating temperature	T _{OP}	-30	+90	°C
HBM ESD Voltage, All Pins	V _{ESD} ¹		2000	V
MM ESD Voltage, All Pins	V _{ESD} ²		190	V

Note 1: Human Body Model ESD Voltage (HBM, MIL_STD 883 Method 3015.7)

Note 2: Machine Model ESD Voltage (MM, JEITA EIAJ ED-4701)

Exceeding absolute maximum ratings may cause permanent damage. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

Electrical and Mechanical Specifications

- The absolute maximum ratings of the RFASWH526BTF03 are provided in Table 2. Electrical specifications are provided in Tables 3 and 5.
- Figure 4, 5 and Table4 describes the RFASWH526BTF03 has four operating states.
- IMD2 and IMD3 test conditions for various frequencies are listed in Tables 6 and 7, respectively.
- Figure 6, 7, 8, 9 and Table8 show the important parameters for SCLK and SDATA required for proper operations of the Toshiba MIPI RFFE slave interface.
- Table 9 register mapping shows the list of the registers inside the RFASWH526BTF03.
- Table 10 provides the switch control register.
- Table 11, 12 and 13 describes the detail information of RFFE status, power mode and trigger states, respectively.
- Figure 10 and Table 14 describes the solder land pad and dimensions...

Table 3. RFASWH526BTF03 DC Electrical Specifications (Note 1)

Parameter	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	VDD	2.5	2.8	3.5	V
Interface supply voltage	VIO	1.65	1.80	1.95	V
Interface signal: High Low	SDATA	0.8 × VIO 0		VIO 0.2 x VIO	V V

Note 1: Performance is guaranteed only under the conditions listed in this Table.



Operating States

The RFASWH526BTF03 has four operating states, which are ACTIVE, SHUTDOWN, STATUP and LOW POWER. The transitions between these four states are set writing the PWR_MODE register or VIO as shown in Figure 4. The internal circuit operations in each operating state are shown in Table 4.

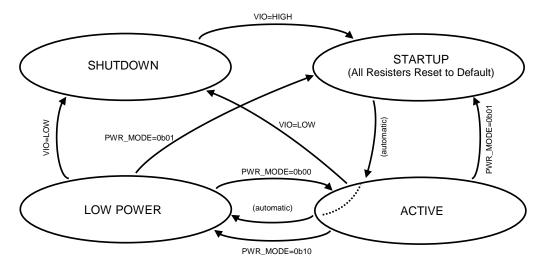


Figure 4. Slave State Diagram

Table 4. RFASWH526BTF03 Internal Operations (Note 1)

Operating State	RFFE Slave Controller	RF Switch Core	Charge Pump
SHUTSOWN	Inactive	Undetermined (Note1)	Off
STARTUP	All registers are set to Default value	Undetermined (Note1)	Off
ACTIVE Active		Controllable by mipi-command	On
LOW POWER Active		Undetermined (Note1)	Off

Note 1: All switch are insufficiently On or Off as the Charge pump is not powered up.

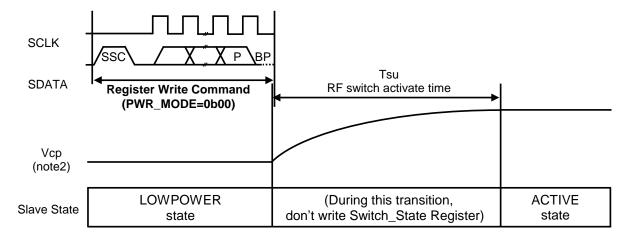


Figure 5. LOW POWER to AVTIVE Process

Note 2: Vcp is the output voltage of internal charge-pump circuit. The Vcp traces in above figure are only image for illustrative purpose.

Table 5. RFASWH526BTF03 RF Electrical Specifications (Note 1)

$(T_{op}=25^{\circ}C, VDD=2.8 \text{ V}, VIO=1.8 \text{V}, Characteristic Impedance } Z_{O}=50 \Omega, Unless Otherwise Noted)$

Parameter	Symbol	Test Condition	Min	Тур.	Max	Units
Operating frequency	f		0.4		2.7	GHz
Insertion loss	IL	TRXx ports: 400 to 960 MHz 1710 to 1980 MHz 1980 to 2690 MHz	-	0.40 0.50 0.76	0.50 0.65 0.90	dB dB dB
Isolation (TRXx to any off TRXx port [non-adjacent ports])	Iso	Up to 1.0 GHz Up to 2.0 GHz Up to 2.7 GHz	30 25 20	42 29 25	-	dB dB dB
Isolation (TRXx to any off TRXx port [adjacent ports])	Iso	Up to 1.0 GHz Up to 2.0 GHz Up to 2.7 GHz	26 20 17	32 25 20	-	dB dB dB
On state match	VSWR	Up to 2.7 GHz		1.43	2.0	_
TRXx harmonics	2fo, 3fo	PIN = +26 dBm, 5:1 VSWR, f = 824 to 2700 MHz		-100	-90	dBc
2 nd Order Intermodulation Distortion	IMD2	See test conditions in Table 6		-104	-100	dBm
3 rd Order Intermodulation Distortion	IMD3	See test conditions in Table 7		-118	-112	dBm
Turn-on time	ton	From application of VDD and VIO			20	μs
Switching speed	ts	Port to port			5	μs

Note 1 : Performance is guaranteed only under the conditions listed in this Table.

Table 6. IMD2 Test Conditions

Band	Transmit Frequency (MHz)	Transmit Power (dBm)	Frequency Blocker, Low (MHz)	Frequency Blocker, High (MHz)	Power Blocker (dBm)	Receive Frequency (MHz)
1	1950.0		190	4090		2140.0
2	1880.0		80	3840		1960.0
4	1732.5	. 20	400	3865	45	2132.5
5	836.5	+20	45	1718	-15	881.5
7	2535.0		120	5190		2655.0
8	897.5		45	1840		942.5

Table 7. IMD3 Test Conditions

Band	Transmit Frequency (MHz)	Transmit Power (dBm)	Frequency Blocker (MHz)	Power Blocker (dBm)	Receive Frequency (MHz)
1	1950.0		1760.0		2140.0
2	1880.0		1800.0		1960.0
4	1732.5	. 20	1332.5	-15	2132.5
5	836.5	+20	791.5		881.5
7	2535.0		2415.0		2655.0
8	897.5		852.5		942.5



Table 8. Digital Interface Timing Specifications

$(T_{op}= 25^{\circ}C, VDD = 2.8 \text{ V}, VIO=1.8 \text{V}, Characteristic Impedance } Z_{o}= 50 \Omega, Unless Otherwise Noted)$

Parameter	Symbol	Condition	Min.	Max.	Unit
Data Setup Time (Note 1)	Ts	See the Figure 6, input Tr/Tf = 3.5 to 6.5ns	1	-	ns
Data Hold Time (Note 1)	Тн	See the Figure 6, input Tr/Tf = 3.5 to 6.5ns	5	-	ns
Time for Data Output Valid from SCLK rising edge (Note 2)	T _D	Half Speed Read See the Figure 6 and 7, input Tr/Tf = 3.5 to 10ns	0	22	ns
SDATA Output Transition (Rise/Fall) Time	TSDATAOTR	Half Speed Read See the Figure 6 and 7, input Tr/Tf = 3.5 to 10ns	2.1	10	ns
Data Drive Release Time	TSDATAZ	Half Speed Read See the Figure 6 and 7, input Tr/Tf = 3.5 to 10ns	1	18	ns
Vio Supply Rise Time	T _{VIO-R}	See the Figure 8	-	400	μs
RFFE I/O Voltage Reset Timing	T _{VIO-RST}	See the Figure 8	10	-	μs
Signal Reset Delay Time	Tsigol	See the Figure 8	120	-	μs
RF Switching Time	T _{SW}	See the Figure 9	-	5	μs
Switching Interval (Note 3)	T _{int}	See the Figure 9	20	-	μs
Startup Time (Note 4)	T _{SU}	See the Figure 4	1	20	μs

Note 1 : Input SDATA is sampled at the falling edge of the SCLK.

Note 2 : Output SDATA changes at the rising edge of the SCLK.

Note 3: The time between the consecutive Register Write Command Sequences for the Switch State register.

Note 4: The time for the switch to reach Active State.

Note: The table of input SCLK signal conditions as below.

Parameter	Symbol	Rati	Unit		
SCLK Fraguenay	F _{SCLK}	Full Speed	0.032 to 26	MHz	
SCLK Frequency	FSCLK	Half Speed	0.032 to 13		
SCLK Period	Teerry	Full Speed	0.038 to 32		
SCLK Period	T _{SCLK}	Half Speed	0.077 to 32	μs	
SCLK Rise/Fall Time	TSCLKITR	Full/Half Speed	3.5 to 6.5	ns	
SCLK Input Duty Cycle, High/Low Time	T _{SCLKDCH} T _{SCLKDCL}	50		%	

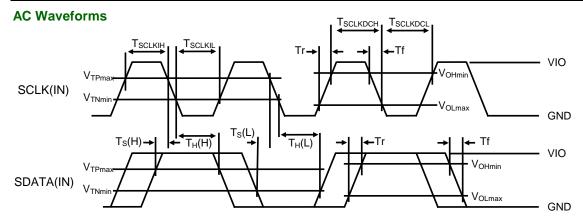


Figure 6. T_{SCLKDH}, T_{SCLKDCL}, T_{SCLKIH}, T_{SCLKIL}, T_S, T_H

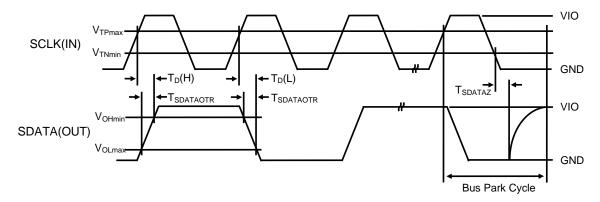


Figure 7. T_D, T_{SDATAOTR}, T_{SDATAZ}

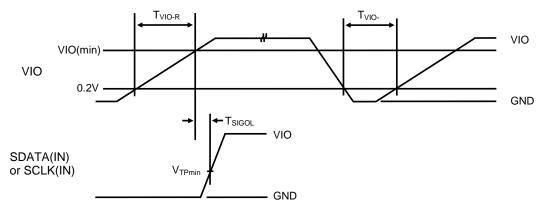


Figure 8. T_{VIO-R}, T_{VIO-RST}, T_{SIGOL}

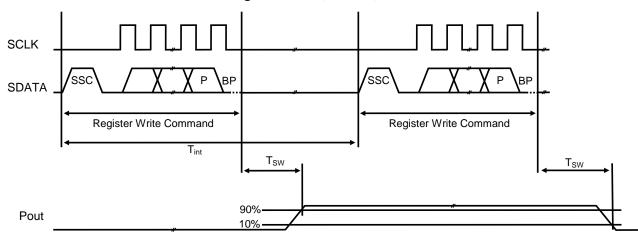


Figure 9. RF Switch Timing



Table 9. Register Mapping

Table 9. shows the list of the registers inside the RFASWH526BTF03.

Register Address		Bits	Read/Write	Description	Default Value
Hex	Binary			•	(binary)
0x00	00000	[7:0]	R/W	Switch Control Register	See Table 10
0x1A	11010	[7:0]	R/W	RFFE Status (see Table 11)	0000 0000
0x1B	11011	[3:0]	R/W	GSID	0000 0000
0x1C	11100	[7:6] [5:0]	R/W	Power Mode (see Table 12) Triggers (see Table 13)	00 000000
0x1D	11101	[7:0]	R	Product ID	0100 1001
0x1E	11110	[7:0]	R	Manufacturer ID [7:0]	0010 0110
	[7.6			SPARE	00
0x1F	11111	[7:6] [5:4]	R	Manufacturer ID [9:8]	01
		[3:0]		USID	1011

Note: The RFASWH526BTF03 start-up procedure as below description.

The RFASWH526BTF03 requires to be disabled the triggers before programming the switch control registers when RFASWH526BTF03 operating in the active mode. The table of register address setup as below.

Register	Address	Bits Read/Write		Value (hinem)	
Hex	Binary	DIES	Reau/Write	Value (binary)	
0x1C	11100	[7:6] [5:0]	R/W	00 111000	

Table 10. Switch Control Register

Antenna Path		Register_0 Bits						
Antenna Patn	Bit[7]	Bit[6]	Bit[5]	Bit[4]	Bit[3]	Bit[2]	Bit[1]	Bit[0]
TRX1	0	0	0	0	0	1	1	0
TRX2	0	0	0	0	0	1	0	1
TRX3	0	0	0	0	0	1	1	1
TRX4	0	0	0	0	0	0	1	1
TRX5	0	0	0	0	1	0	0	1
TRX6	0	0	0	0	0	0	0	1
Sleep	0	0	0	0	0	0	0	0
Isolation mode	0	1	1	1	1	1	1	1

Table 11. RFFE Status

D[7:0]	Read/Write	Description
D[7]	R/W	SOFTWARE RESET
D[6]		COMMAND_FRAME_ PARITY_ERR
D[5]		COMMAND_LENGTH_ERR
D[4]		ADDRESS_FRAME_PARITY_ERR
D[3]	R	DATA_FRAME_PARITY_ERR
D[2]		READ_UNUSED_REG
D[1]		WRITE_UNUSED_REG
D[0]		BID_GID_ERR

Table 12. Power Mode

D[7:6]	Read/Write	Status	
00b	W	Part enters Active mode	
OOD	R	Part is in Active mode	
01h	W	Part enters Start Up mode - part is reset	
01b R		Start Up mode will immediately transition to Low Power mode	
10h	W Part enters Low Power mode		
10b R		Part is in Low Power mode	
11b	N/A	Will not occur - The state is discarded	
110	IN/A	Will not occur - The state is discarded	

Table 13. Trigger States

D[5:0]	Read/Write	Status
D[5]		1 = Trigger 2 Disabled, 0 = Trigger 2 Enabled
D[4]	R/W	1 = Trigger 1 Disabled, 0 = Trigger 1 Enabled
D[3]		1 = Trigger 0 Disabled, 0 = Trigger 0 Enabled
D[2]		1 = Load Bits to Trigger 2, Trigger 2 states is Disabled
D[1]	W	1 = Load Bits to Trigger 1, Trigger 1 states is Disabled
D[0]		1 = Load Bits to Trigger 0, Trigger 0 states is Disabled

Table 14. Dimensions

	Figure		Symbol	Dimension
Pin 1			L	2.0 ± 0.1mm
Index			W	2.0 ± 0.1mm
	- T	Н	Т	0.55 ± 0.07mm
			А	0.18 ± 0.05mm
			В	0.40 ± 0.05mm
5 ≥			С	0.21 ± 0.05mm
526			D	1.0 ± 0.05mm
			E	1.0 ± 0.05mm
		A B	F	0.18 ± 0.05mm
Top View	Side View	Bottom View	G	0.45 ± 0.05mm
			Н	0.21 ± 0.05mm
			I	0.15 x 0.15mm

Solder land pattern for reference only

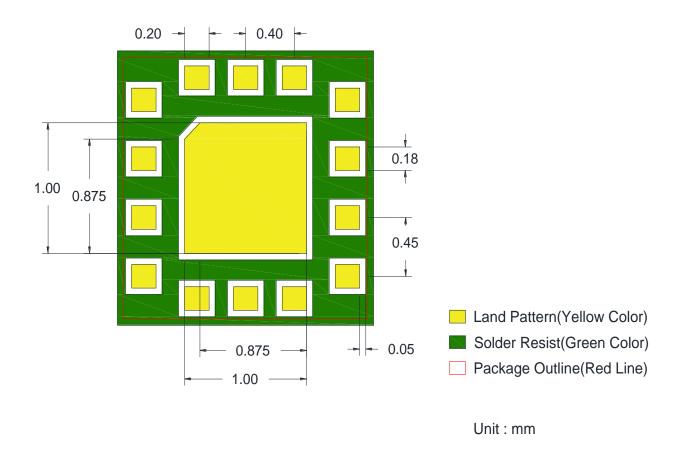


Figure 10. Solder Land Pattern Top View



Reliability test

TEST	PROCEDURE / TEST METHOD	REQUIREMENT
Solderability	*Solder bath temperature: 255 ± 5°C	At least 95% of a surface of each terminal
JIS C 0050-4.6	*Immersion time : 5 ± 0.5 sec	electrode must be covered by fresh solder.
JESD22-B102D	Solder: Sn3Ag0.5Cu for lead-free	
High temperature	*Temperature : 90°C±2°C	No mechanical damage.
JIS C 0021	*Test duration: 1000+24/-0 hours	Electrical specification shall satisfy the
	Measurement to be made after keeping at	descriptions in electrical characteristics
	room temperature for 24±2 hrs	under the operational temperature range
		within -30 ~ 90°C.
Low temperature	*Temperature: -30°C±2°C	No mechanical damage.
JIS C 0020	*Test duration: 1000+24/-0 hours	Electrical specification shall satisfy the
	Measurement to be made after keeping at	descriptions in electrical characteristics
	room temperature for 24±2 hrs	under the operational temperature range
		within -30 ~ 90°C.
Temperature cycle	1. 30±3 minutes at -30±3°C,	No mechanical damage.
JIS C 0025	2. 10~15 minutes at room temperature,	Electrical specification shall satisfy the
	3. 30±3 minutes at +90±3°C,	descriptions in electrical characteristics
	4. 10~15 minutes at room temperature,	under the operational temperature range
	Total 100 continuous cycles	within -30 ~ 90°C.
	Measurement to be made after keeping at	
	room temperature for 24±2 hrs	
High temperature operation	*Temperature: 90°C	No mechanical damage.
life (HTOL)	*VDD = 4.8V	Electrical specification shall satisfy the
	*Time: 1000+24/-0 hrs.	descriptions in electrical characteristics
	Measurement to be made after keeping at	under the operational temperature range
	room temperature for 24±2 hrs	within -30 ~ 90°C.

Soldering condition

Typical examples of soldering processes that provide reliable joints without any damage are given in Figure 11.

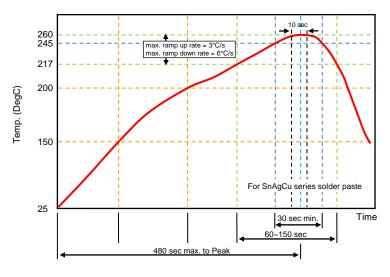


Figure 11. Infrared soldering profile

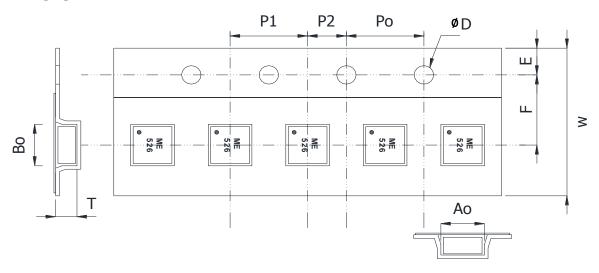


Ordering code

RF	ASW	Н	526B	Т
RF module	Module type	Application	Design Code	Packing
RF:	ASW: Antenna Switch	H: SP6T		T: Taping
Walsin RF Switch				
Device				

Minimum Ordering Quantity: 3000 pcs per reel.

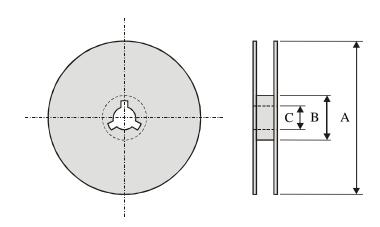
Packaging



Plastic Tape specifications (unit :mm)

Index	Ao	Во	ΦD	Т	W
Dimension (mm)	2.15 ± 0.10	2.15 ± 0.10	1.50 ± 0.05	0.95 ± 0.10	8.0 ± 0.10
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05

Reel dimensions



Index	А	В	С	
Dimension (mm)	Ф178.0	Ф60.0	Ф13.0	

Taping Quantity: 3000 pieces per 7" reel



Caution of handling

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

Temperature : -10 to +40°C

Humidity : 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF Switch ICs category:

Click to view products by Walsin manufacturer:

Other Similar products are found below:

MASW-007921-002SMB BGSA142GN12E6327XTSA1 BGSA142MN12E6327XTSA1 BGSA142M2N12E6327XTSA1 MASW-00410011930W MASW-008853-TR3000 BGS13SN8E6327XTSA1 BGSF18DM20E6327XUMA1 BGSX210MA18E6327XTSA1

BGSX212MA18E6327XTSA1 SKY13446-374LF SW-227-PIN PE42524A-X CG2185X2 CG2415M6 MA4AGSW1A MA4AGSW2

MA4AGSW3 MA4AGSW5 MA4SW210B-1 MA4SW410 MASW-002102-13580G BGS 12PL6 E6327 BGS1414MN20E6327XTSA1

BGS1515MN20E6327XTSA1 BGSA11GN10E6327XTSA1 BGSX28MA18E6327XTSA1 HMC199AMS8 HMC595AETR HMC986A

SKY13374-397LF SKY13453-385LF CG2430X1-C2 TGS4304 UPG2162T5N-A CG2415M6-C2 AS222-92LF SW-314-PIN

UPG2162T5N-E2-A BGS18GA14E6327XTSA1 MASWSS0204TR-3000 MASWSS0201TR MASWSS0181TR-3000 MASW-007588
TR3000 MASW-007075-000100 MASW-004103-13655P MASW-003102-13590G MASWSS0202TR-3000 MASW-008543-TR3000

MA4SW310B-1